

Thin Film Metrology Using Wavefront Sensing.

ADAPTIVE OPTICS

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Overview Of Presentation.

- What is Adaptive Optics and how can we use it for metrology.
- Project aims.
- Analysis of measurement and experimental set-up.
- Results To Date and System Calibration.
- Future Work and sensor design.
- Conclusions.







Typical AO Vs Metrology.



Metrology Using AO







Project Aims.



- Produce robust industrial thickness monitor.
- Sensor must be able to be used in-line for control feedback.
- Sensor should be able to measure coloured films.
- Sensor should be able to cope with rough sample surfaces.
- Sensor should be able to be used with multiple layer laminates.
- Accuracy dependent on application, could be as low as 10nm.











Results To Date.







System Calibration.



- Our optical system requires calibration before we can relate pixel separation to actual thickness.
- Separation will change with angle of illumination, magnification of optical system, thickness, refractive index and surface tilt.
- Number of options :
 - Absolute calibration with prism + model of refraction.
 - Relative calibration with calibrated sample set.
 - Calibration with system model.
- Choice will be dependent on application.







- Results from four samples ranging from 250 to 500 microns.
- Lets make 500 micron sample our calibration sample. Actual thickness 480 microns, use pixel separation to get calibration value to gain measure of pixels/micron for system.

Sample	Nominal Thickness (µm)	Measured Thickness (µm)
450 Micron	426 +/- 5 µm	423.6 +/- 7.7 µm
350 Micron	378 +/- 4.47 µm	377.3 +/- 6.3 μm
250 Micron	234 +/- 5.47 µm	235.8 +/- 5.48 µm









- Phase Diversity Wavefront sensor used to measure aberrations introduced by the film structure.
- Addition of diffractive optical element to current set-up.
- Use of generalised phase diversity to optimise DOE design for thickness measurement.
- Design sensor to be most sensitive to aberrations expected.
 - Tilt, Defocus, Astigmatism, Coma, Spherical, Trefoil





- Small compact sensor design
- Can be mounted on industrial scanner



HERIO



Future Work.



- Model wavefront sensor system using plane wave decomposition.
- Use model results to design appropriate DOE for sensor.
- Incorporate DOE into current system and test.
- Investigate application to curved and textured surfaces.
- Investigate simultaneous measurement of thickness and refractive index.





Conclusions.



- Current measurement can be used for films 8mm to 12 microns.
- Technique should be able to work down to below 3 microns.
- Experimentally shown linear relationship between virtual source position and thickness.
- Shown that relative calibration approach can be accurate.
- Shown that sensor should be compact and will be able to be used in-line in industrial processes.

